

2SB0789, 2SB0789A (2SB789, 2SB789A)

Silicon PNP epitaxial planar type

For low-frequency driver amplification

Complementary to 2SD0968 (2SD968) and 2SD0968A (2SD968A)

Features

- High collector to emitter voltage V_{CEO} .
- Large collector power dissipation P_C .

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rated	Unit
Collector to base voltage	V_{CBO}	-100	V
Collector to emitter voltage		-120	
Collector to emitter voltage	V_{CEO}	-100	V
Collector to emitter voltage		-120	
Emitter to base voltage	V_{EBO}	-5	V
Peak collector current	I_{CP}	-1	A
Collector current	I_C	-0.5	A
Collector power dissipation	P_C^*	1	W
Junction temperature	T_j	150	°C
Storage temperature	T_{stg}	-55 ~ +150	°C

* Printed circuit board: Copper foil area of 1cm² or more, and the board thickness of 1.7mm for the collector portion

Electrical Characteristics (Ta=25°C)

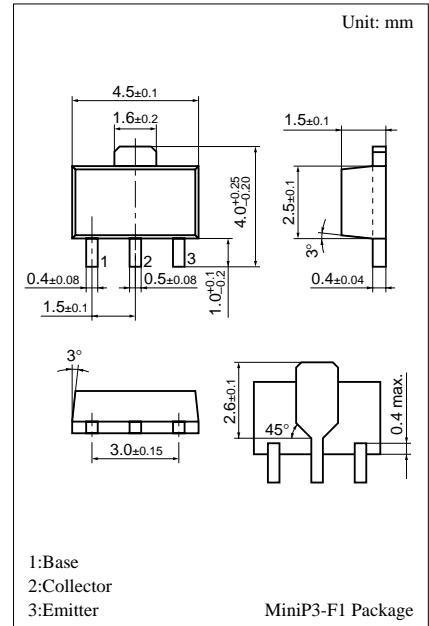
Parameter	Symbol	Conditions	min	typ	max	Unit
Collector to emitter voltage	V_{CEO}	$I_C = -100\mu A, I_B = 0$	-100			V
Collector to emitter voltage			-120			
Collector to base voltage	V_{EBO}	$I_E = -10\mu A, I_C = 0$	-5			V
Forward current transfer ratio *1	h_{FE1}^{*2}	$V_{CE} = -10V, I_C = -150mA$	90		220	
	h_{FE2}	$V_{CE} = -5V, I_C = -500mA$	50			
Collector to emitter saturation voltage *1	$V_{CE(sat)}$	$I_C = -500mA, I_B = -50mA$		-0.2	-0.6	V
Base to emitter saturation voltage *1	$V_{BE(sat)}$	$I_C = -500mA, I_B = -50mA$		-0.85	-1.2	V
Transition frequency	f_T	$V_{CB} = -10V, I_E = 50mA, f = 200MHz$		120		MHz
Collector output capacitance	Cob	$V_{CB} = -10V, I_E = 0, f = 1MHz$			30	pF

*1: Pulse measurement

*2: h_{FE1} Rank classification

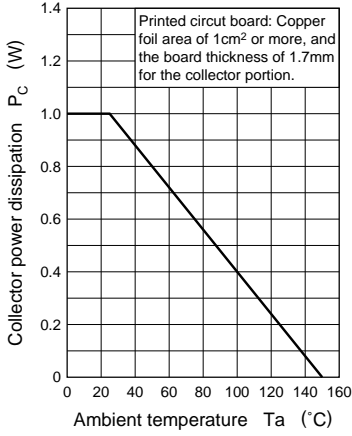
Rank	Q	R
h_{FE1}	90 ~ 155	130 ~ 220
Marking	2SB0789	DQ
Symbol	2SB0789A	EQ

Note.) The Part numbers in the Parenthesis show conventional part number.

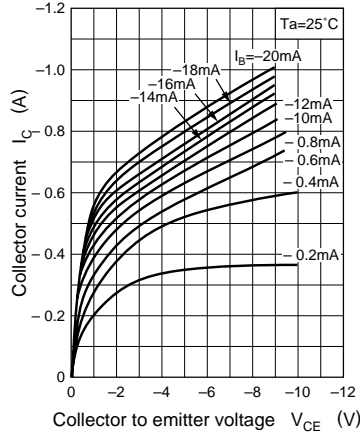


Marking symbol : D(2SB0789)
E(2SB0789A)

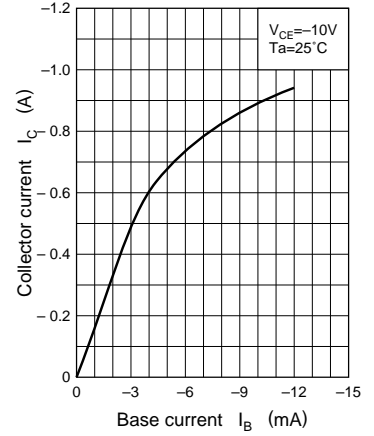
$P_C - T_a$



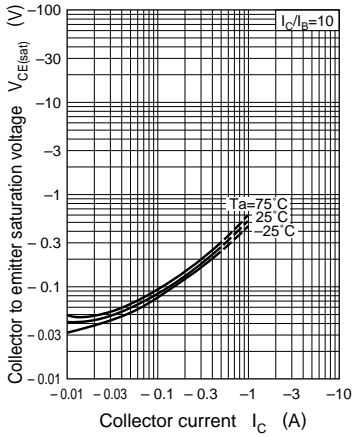
$I_C - V_{CE}$



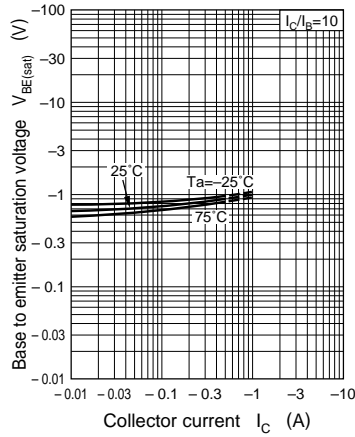
$I_C - I_B$



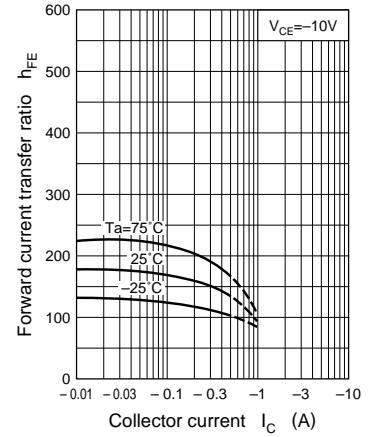
$V_{CE(sat)} - I_C$



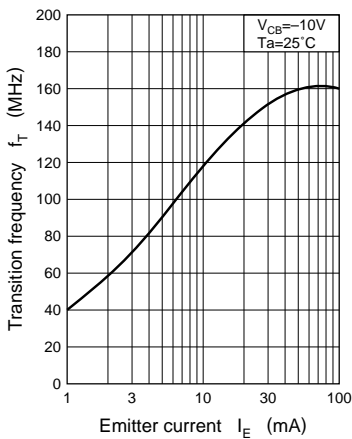
$V_{BE(sat)} - I_C$



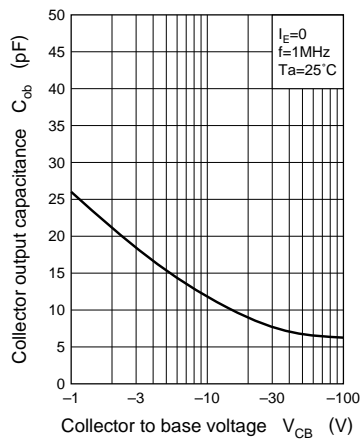
$h_{FE} - I_C$



$f_T - I_E$



$C_{ob} - V_{CB}$



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